Total number of printed pages: 2

no

2022

ELECTRONIC DEVICES

Full Marks : 100

Time : Three hours

The figures in the margin indicate full marks for the questions.

Answer any five questions.

| 1. | a) | Explain the lattice structure of single crystalline Silicon with the help of a | 5 |
|----|-----|---|------|
| | | diagram and compute the volume density of Si atoms in this structure. | |
| | b) | Compare the surface density of (100) and (111) Si-crystal planes. | 5 |
| | c) | Write the Schrodinger equation for a particle inside a 3D infinite-wall | 10 |
| | | potential box and determine its complete solution. | |
| 2. | a) | State Bloch's theorem and explain its physical significance. Write all the | 2+6 |
| | | four boundary conditions for a Kronig-Penny potential. | |
| | b) | For a particle in a periodic 1D potential $V(x) = V_0 \sum_{k=-\infty}^{\infty} \delta(x - ka)$, | 10+2 |
| | | show that certain energy ranges are forbidden. Draw the resulting reduced | |
| | | bandstructure diagram. | |
| 3. | a) | Explain the concept of effective mass of charge carriers in semiconductors. | 5 |
| | b) | Derive the expression for the number of electrons and holes in | 6+4 |
| | | Semiconductors using Boltzmann approximation. Using it, determine the | |
| | | location of Fermi-level for intrinsic semiconductors. | |
| | c) | Show that the occupation of donor impurity level is negligible at room | 5 |
| | | temperature. | |
| 4. | a) | Draw the charge density, electric field and electric potential varies for a p-n | 6 |
| | - (| junction diode as a function of position. | |
| | b) | Differentiate between drift and diffusion current components of electrons. | 6 |
| | | In equilibrium condition, show that a built-in potential will be developed | |
| | | across a p-junction. | |
| | c) | Derive the expression for the depletion region width across a reverse-biased | 8 |
| | | p-n junction diode. | |
| 5. | a) | Derive the expression for continuity equation for holes in a semiconductor. | 5+5 |
| | | Solve it show how the minority carrier concentration profile on the n-side | |
| | | of a p-n junction diode under forward bias. | |

| | b) | State the law of junction. Draw and show how different components of | 2+4+4 |
|----|-----|---|-------|
| | | currents vary along the length of a p-n junction diode. Plot the V-I | |
| | | characteristics of a n_n junction diode and derive the value of its dynamic | |
| | | enaracteristics of a p-in junction didde and derive the value of its dynamic | |
| | | resistance under forward bias condition. | |
| 6. | a) | Draw energy band diagram for a p-n-p transistor at equilibrium and after | 6 |
| | | the application of Forward Active bias | |
| | | | |
| | b) | Define (i) emitter injection ratio, (ii) base transport factor and (iii) | 6 |
| | | Common-Base current gain for a n-n-n transistor | |
| | | common Duse current gam for a p n p transistor. | 4 |
| | c) | Express the collector current as a function of base current and explain the | 4+4 |
| | | output characteristics in common-emitter configuration. What is base width | |
| | | modulation and avalain have it affasts the output shows to initial | |
| | | modulation and explain now it affects the output characteristics? | |
| 7. | a) | With the help of neat schematic diagram explain the working of an n- | 6 |
| | | channel JFET for zero and reverse bias junction voltage. | |
| | 1 | | (|
| | (b) | Using energy band diagram, explain the mechanism of funnelling in Zener | 6 |
| | | diode during its breakdown. | |
| | c) | Explain the process steps involved to fabricate an n-channel MOSFET in a | 8 |
| | | n-type wafer. | |
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